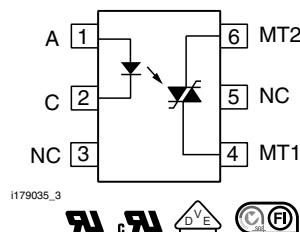
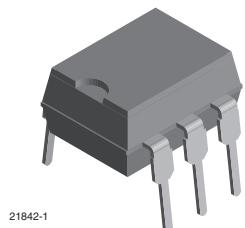


Optocoupler, Phototriac Output, High dV/dt, Low Input Current



DESCRIPTION

The VO4254 and VO4256 phototriac consists of a GaAs IRLED optically coupled to a photosensitive non-zero crossing TRIAC packaged in a DIP-6 package.

High input sensitivity is achieved by using an emitter follower phototransistor and a cascaded SCR predriver resulting in an LED trigger current of 1.6 mA for bin D, 2 mA for bin H, and 3 mA for bin M.

The new non zero phototriac family use a proprietary dV/dt clamp resulting in a static dV/dt of greater than 5 kV/μs.

The VO4254 and VO4256 phototriac isolates low-voltage logic from 120 V_{AC}, 240 V_{AC}, and 380 V_{AC} lines to control resistive, inductive, or capacitive loads including motors, solenoids, high current thyristors or TRIAC and relays.

FEATURES

- High static dV/dt 5 kV/μs
- High input sensitivity 1.6 mA, 2 mA, and 3 mA
- 400 V and 600 V blocking voltage
- 300 mA on-state current
- Isolation test voltage 5300 V_{RMS}
- Material categorization:
For definitions of compliance please see
www.vishay.com/doc?99912



RoHS
COMPLIANT

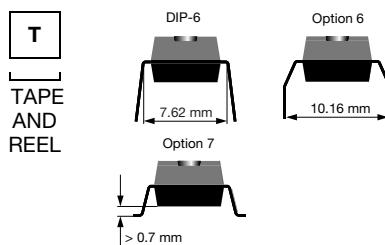
APPLICATIONS

- Solid-state relays
- Industrial controls
- Office equipment
- Consumer appliances

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- cUL - file no. E52744, equivalent to CSA bulletin 5A
- DIN EN 60747-5-5 (VDE 0884) available with option 1
- FIMKO: FI25250

| ORDERING INFORMATION | | | | | | | | | | | | |
|--------------------------|--|----------------------|---------------|---------------|---------------|----------------------|----------------|-----|---|---|-----|---|
| PART NUMBER | | | | | | | PACKAGE OPTION | | | | | |
| AGENCY CERTIFIED/PACKAGE | | V _{DRM} 400 | | | | V _{DRM} 600 | | | | | | |
| UL, cUL, FIMKO | | 1.6 | 2 | 3 | 1.6 | 2 | 3 | 1.6 | 2 | 3 | 1.6 | 2 |
| DIP-6 | | VO4254D | VO4254H | VO4254M | VO4256D | VO4256H | VO4256M | | | | | |
| DIP-6, 400 mil, option 6 | | VO4254D-X006 | VO4254H-X006 | VO4254M-X006 | VO4256D-X006 | VO4256H-X006 | VO4256M-X006 | | | | | |
| SMD-6, option 7 | | VO4254D-X007T | VO4254H-X007T | VO4254M-X007T | VO4256D-X007T | VO4256H-X007T | VO4256M-X007T | | | | | |
| UL, cUL, FIMKO, VDE | | 1.6 | 2 | 3 | 1.6 | 2 | 3 | 1.6 | 2 | 3 | 1.6 | 2 |
| DIP-6 | | - | - | - | VO4256D-X001 | - | - | - | - | - | - | - |



| ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified) | | | | | |
|--|--|-------------|------------|---------------|------------------------|
| PARAMETER | TEST CONDITION | PART | SYMBOL | VALUE | UNIT |
| INPUT | | | | | |
| Reverse voltage | | | V_R | 6 | V |
| Forward current | | | I_F | 60 | mA |
| Power dissipation | | | P_{diss} | 100 | mW |
| Derate from 25°C | | | | 1.33 | mW/ $^{\circ}\text{C}$ |
| OUTPUT | | | | | |
| Peak off-state voltage | | VO4254D/H/M | V_{DRM} | 400 | V |
| | | VO4256D/H/M | V_{DRM} | 600 | V |
| RMS on-state current | | | I_{TM} | 300 | mA |
| Power dissipation | | | P_{diss} | 500 | mW |
| Derate from 25°C | | | | 6.6 | mW/ $^{\circ}\text{C}$ |
| <b b="" coupler<=""> | | | | | |
| Isolation test voltage (between emitter and detector, climate per DIN 500414, part 2, Nov. 74) | $t = 1\text{ s}$ | | V_{ISO} | 5300 | V_{RMS} |
| Storage temperature range | | | T_{stg} | - 55 to + 150 | $^{\circ}\text{C}$ |
| Ambient temperature range | | | T_{amb} | - 55 to + 100 | $^{\circ}\text{C}$ |
| Soldering temperature ⁽²⁾ | max. $\leq 10\text{ s}$ dip soldering $\geq 0.5\text{ mm}$ from case bottom | | T_{sld} | 260 | $^{\circ}\text{C}$ |

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of time can adversely affect reliability.

⁽¹⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

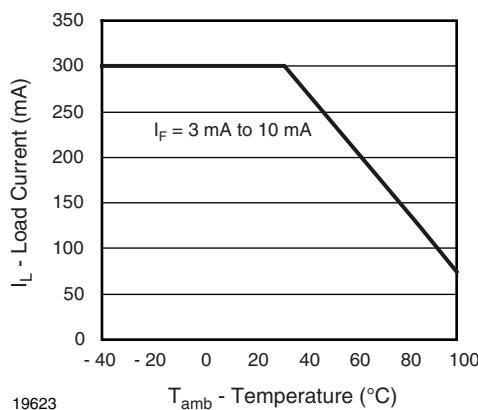
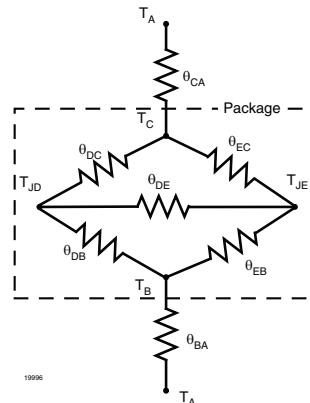


Fig. 1 - Recommended Operating Condition

THERMAL CHARACTERISTICS

| PARAMETER | SYMBOL | VALUE | UNIT | |
|---|----------------|-------|------|--|
| LED power dissipation | P_{diss} | 100 | mW | |
| Output power dissipation | P_{diss} | 500 | mW | |
| Maximum LED junction temperature | $T_{jmax.}$ | 125 | °C | |
| Maximum output die junction temperature | $T_{jmax.}$ | 125 | °C | |
| Thermal resistance, junction emitter to board | θ_{JEB} | 150 | °C/W | |
| Thermal resistance, junction emitter to case | θ_{JEC} | 139 | °C/W | |
| Thermal resistance, junction detector to board | θ_{JDB} | 78 | °C/W | |
| Thermal resistance, junction detector to case | θ_{JDC} | 103 | °C/W | |
| Thermal resistance, junction emitter to junction detector | θ_{JED} | 496 | °C/W | |
| Thermal resistance, case to ambient | θ_{CA} | 3563 | °C/W | |


Note

- The thermal characteristics table above were measured at 25 °C and the thermal model is represented in the thermal network below. Each resistance value given in this model can be used to calculate the temperatures at each node for a given operating condition. The thermal resistance from board to ambient will be dependent on the type of PCB, layout and thickness of copper traces. For a detailed explanation of the thermal model, please reference Vishay's Thermal Characteristics of Optocouplers application note.

ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|--|---|-------------|--------------|------|------|------|------|
| INPUT | | | | | | | |
| Forward voltage | $I_F = 10 \text{ mA}$ | | V_F | | 1.2 | 1.4 | V |
| Reverse current | $V_R = 6 \text{ V}$ | | I_R | | 0.1 | 10 | μA |
| Input capacitance | $V_F = 0 \text{ V}, f = 1 \text{ MHz}$ | | C_I | | 40 | | pF |
| OUTPUT | | | | | | | |
| Repetitive peak off-state voltage | $I_{DRM} = 100 \mu\text{A}$ | VO4254D/H/M | V_{DRM} | 400 | | | V |
| | | VO4256D/H/M | V_{DRM} | 600 | | | V |
| Off-state current | $V_D = V_{DRM}$ | | I_{DRM} | | | 100 | μA |
| On-state voltage | $I_T = 300 \text{ mA}$ | | V_{TM} | | | 3 | V |
| On-current | $PF = 1, V_{T(RMS)} = 1.7 \text{ V}$ | | I_{TM} | | | 300 | mA |
| Critical rate of rise of off-state voltage | $V_D = 0.67 V_{DRM}, T_J = 25 \text{ °C}$ | | dV/dt_{cr} | 5000 | | | V/μs |
| COUPLER | | | | | | | |
| LED trigger current, current required to latch output | $V_D = 3 \text{ V}$ | VO4254D | I_{FT} | | | 1.6 | mA |
| | | VO4254H | I_{FT} | | | 2 | mA |
| | | VO4254M | I_{FT} | | | 3 | mA |
| | | VO4256D | I_{FT} | | | 1.6 | mA |
| | | VO4256H | I_{FT} | | | 2 | mA |
| | | VO4256M | I_{FT} | | | 3 | mA |
| Capacitance (input to output) | $f = 1 \text{ MHz}, V_{IO} = 0 \text{ V}$ | | C_{IO} | | 0.8 | | pF |

Note

- Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

| SAFETY AND INSULATION RATINGS | | | | | | |
|--|----------------|------------|------|-----------|------|------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Climatic classification (according to IEC68 part 1) | | | | 55/100/21 | | |
| Pollution degree (DIN VDE 0109) | | | | 2 | | |
| Comparative tracking index per DIN IEC112/VDE 0303 part 1, group IIIa per DIN VDE 6110 175 399 | | | 175 | | 399 | |
| V_{IOTM} | | V_{IOTM} | 8000 | | | V |
| V_{IORM} | | V_{IORM} | 890 | | | V |
| P_{SO} | | P_{SO} | | | 500 | mW |
| I_{SI} | | I_{SI} | | | 250 | mA |
| T_{SI} | | T_{SI} | | | 175 | °C |
| Creepage distance | | | 7 | | | mm |
| Clearance distance | | | 7 | | | mm |

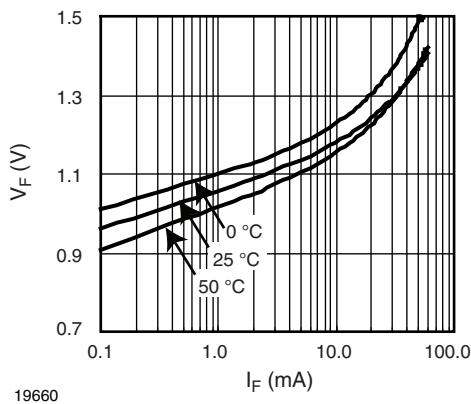
TYPICAL CHARACTERISTICS ($T_{amb} = 25$ °C, unless otherwise specified)


Fig. 2 - Diode Forward Voltage vs. Forward Current

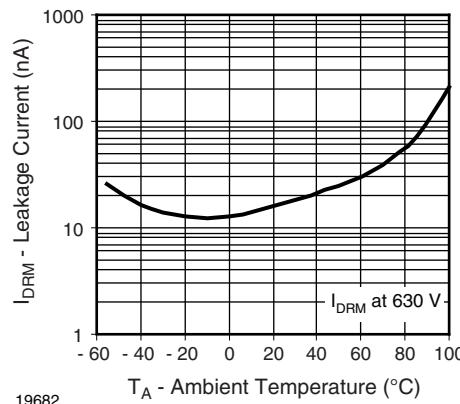


Fig. 4 - Leakage Current vs. Ambient Temperature

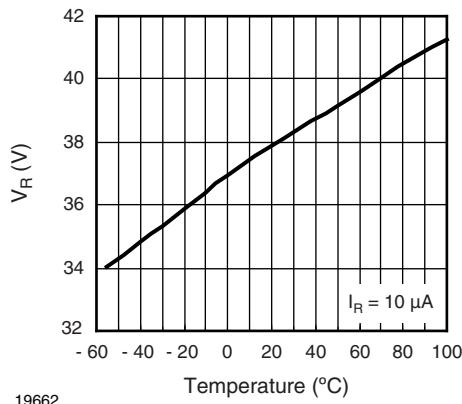


Fig. 3 - Diode Reverse Voltage vs. Temperature

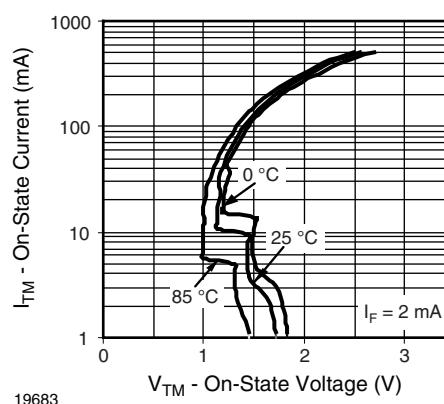


Fig. 5 - On-State Current vs. On-State Voltage

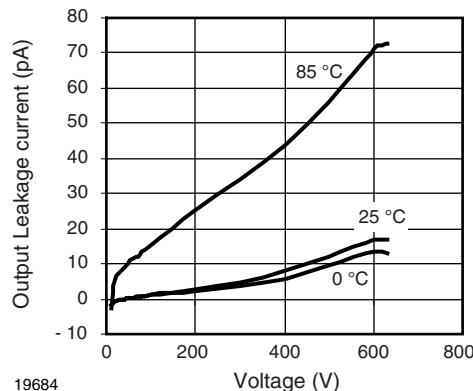


Fig. 6 - Output Off Current (Leakage) vs. Voltage

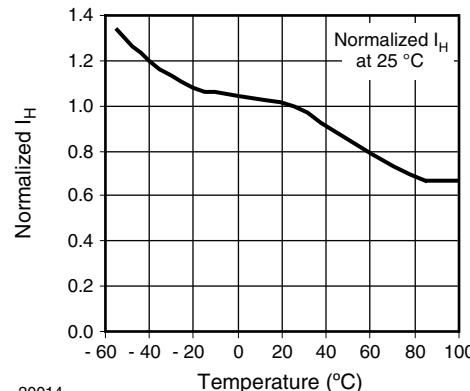
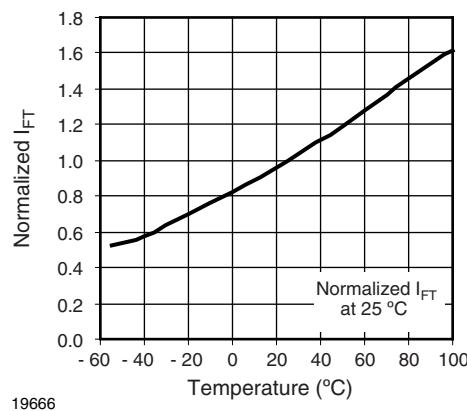
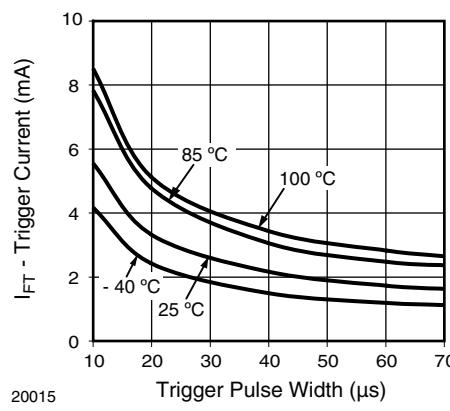
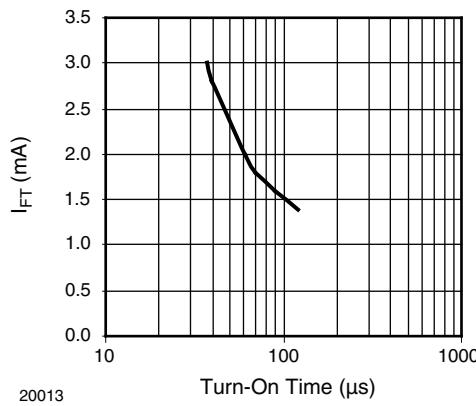
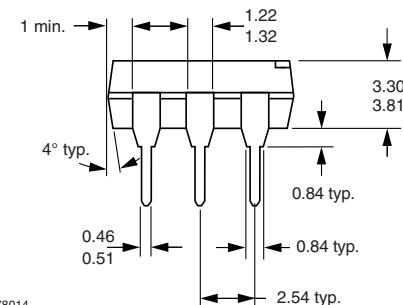
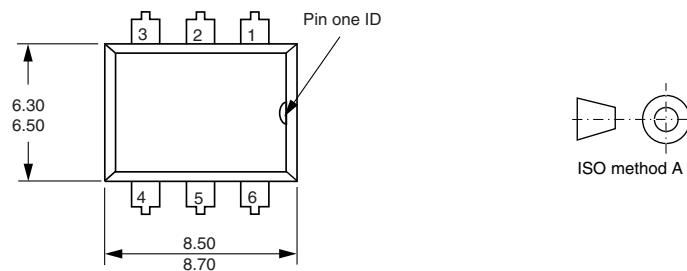
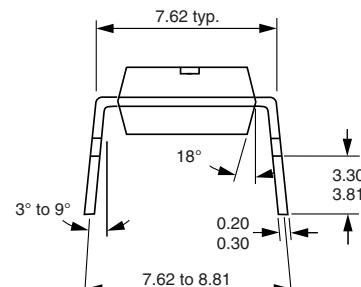
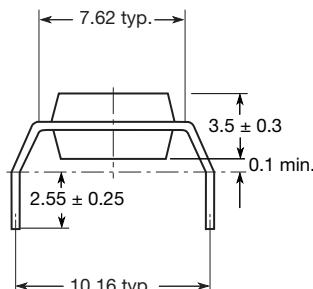
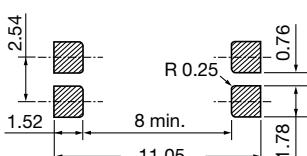
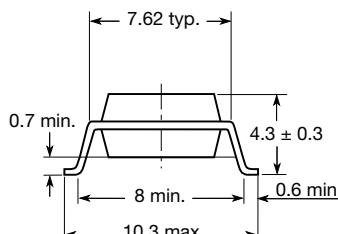

Fig. 9 - Normalized I_H vs. Temperature


Fig. 7 - Normalized Trigger Input Current vs. Temperature


Fig. 10 - I_{FT} vs. LED Pulse Width

Fig. 8 - I_{FT} vs. Turn-On Time (μs)

PACKAGE DIMENSIONS in millimeters

Option 6

Option 7


20802-18


PACKAGE MARKING (example)

Note

- VDE logo is only marked on option 1 parts. Tape and reel suffix (T) is not part of the package marking.



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